



#### 60V P-CHANNEL ENHANCEMENT MODE MOSFET

## **Product Summary**

V <sub>(BR)DSS</sub>	R <sub>DS(on)</sub>	Ι <sub>D</sub> T <sub>A</sub> = +25°C
-60V	150mΩ @ V <sub>GS</sub> = -10V	-3A
-007	185mΩ @ V <sub>GS</sub> = -4.5V	-2.7A

#### Description

This MOSFET has been designed to minimize the on-state resistance and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

## Applications

- Motor Control
- Transformer Driving Switch
- DC-DC Converters
- Power Management Functions
- Uninterrupted Power Supply

### Features and Benefits

- 100% Unclamped Inductive Switch (UIS) test in production
- Low on-resistance
- Fast switching speed
- Lead-Free Finish; RoHS compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

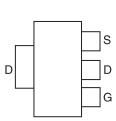
## **Mechanical Data**

- Case: SOT223
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals Connections: See diagram below
- Terminals: Finish Matte Tin annealed over Copper lead frame. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.112 grams (approximate)



**SOT223** 

Top View



Pin Out - Top View

G

Equivalent Circuit

## Ordering Information (Note 4)

Part Number	Our lift and an	-	
i alt italisoi	Qualification	Case	Packaging
DMP6185SE-13	Standard	SOT223	2,500 / Tape & Reel

1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.

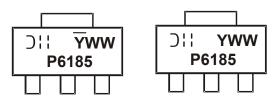
 See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

## **Marking Information**

Notes:





## Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Drain-Source voltage		V <sub>DSS</sub>	-60	V
Gate-Source voltage		V <sub>GS</sub>	±20	V
	T <sub>A</sub> = +25°C		-3	•
Continuous Drain current (Note 6) $V_{GS}$ = -10V	T <sub>A</sub> = +70°C	ID	-2.4	A
Maximum Body Diode Continuous Current		Is	-2	A
Pulsed Drain Current (10µs pulse, duty cycle = 1%)		I <sub>DM</sub>	-15	A
Single Pulsed Avalanche Current (Note 7)		I <sub>AS</sub>	-16	A
Single Pulsed Avalanche Energy (Note 7)		E <sub>AS</sub>	13	mJ

## Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units	
Total Dower Dissinction (Note 5)	T <sub>A</sub> = +25°C	D	1.2	W
Total Power Dissipation (Note 5)	T <sub>A</sub> = +70°C	PD	0.8	
Thermal Resistance, Junction to Ambient (Note 5)	Steady state	Р	104	°C/W
Thermal Resistance, Junction to Ambient (Note 5)	t<10s	$R_{\theta JA}$	51	
Total Dower Dissinction (Note 6)	T <sub>A</sub> = +25°C	6	2.2	w
Total Power Dissipation (Note 6)	T <sub>A</sub> = +70°C	PD	1.4	
Thermal Desistance Junction to Ambient (Note 6)	Steady state		60	°C/W
Thermal Resistance, Junction to Ambient (Note 6)	t<10s	R <sub>0JA</sub>	30	
Thermal Resistance, Junction to Case (Note 6)	R <sub>θJC</sub>	7.6		
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

## Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

		-					
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	-60	-	-	V	$V_{GS} = 0V, I_D = -250\mu A$	
Zero Gate Voltage Drain Current	IDSS	_	-	-1	μA	$V_{DS}$ = -48V, $V_{GS}$ = 0V	
Gate-Source Leakage	I <sub>GSS</sub>	-	-	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	V <sub>GS(th)</sub>	-1	-	-3	V	$V_{DS} = V_{GS}, I_D = -250 \mu A$	
Static Drain-Source On-Resistance			110	150	mΩ	V <sub>GS</sub> = -10V, I <sub>D</sub> = -2.2A	
Static Drain-Source On-Resistance	R <sub>DS</sub> (ON)	-	130	185	11122	V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -1.8A	
Diode Forward Voltage	V <sub>SD</sub>	-	-0.75	-0.95	V	V <sub>GS</sub> = 0V, I <sub>S</sub> = -1A	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	C <sub>iss</sub>	_	708	-	pF	V <sub>DS</sub> = -30V, V <sub>GS</sub> = 0V, f = 1MHz	
Output Capacitance	C <sub>oss</sub>	-	39	-	рF		
Reverse Transfer Capacitance	Crss	-	32	-	pF	1 - 110112	
Gate Resistance	Rg	-	17	28	Ω	$V_{DS}$ = 0V, $V_{GS}$ = 0V, f = 1MHz	
Total Gate Charge (V <sub>GS</sub> = -4.5V)	Qg	-	6.2	-	nC		
Total Gate Charge (V <sub>GS</sub> = -10V)	Qg	-	14	-	nC	$y_{1} = 20y_{1} + 120$	
Gate-Source Charge	Q <sub>gs</sub>	_	2.8	-	nC	$-V_{DS} = -30V, I_{D} = -12A$	
Gate-Drain Charge	Q <sub>gd</sub>	-	3.1	-	nC		
Turn-On Delay Time	t <sub>D(on)</sub>	-	5.2	_	ns		
Turn-On Rise Time	tr	-	23	-	ns	V <sub>DS</sub> = -30V, R <sub>L</sub> = 2.5Ω	
Turn-Off Delay Time	t <sub>D(off)</sub>	-	33	-	ns	$V_{GS}$ = -10V, $R_{G}$ = 3 $\Omega$	
Turn-Off Fall Time	t <sub>f</sub>	-	39	-	ns	7	
Body Diode Reverse Recovery Time	trr	-	22	-	ns		
Body Diode Reverse Recovery Charge	Qrr	-	17	-	nC	—I <sub>F</sub> = -12A, di/dt = 100A/μs	

5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout. 6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate. 7. UIS in production with L = 0.1mH, starting  $T_A = +25^{\circ}C$ .

Short duration pulse test used to minimize self-heating effect.
Guaranteed by design. Not subject to product testing.

Notes:



= 85°C Δ

2.5

3

25°C

-55°C

2

T<sub>A</sub> = 150°C

1.5

-V<sub>GS</sub>, GATE-SOURCE VOLTAGE (V)

Figure 2 Typical Transfer Characteristics

= 4.2A

 $I_D$ 

= 125°C

TA

3.4A

1

-25

0

25

50

T<sub>J</sub>, JUNCTION TEMPERATURE (°C)

75

100

125

2

3

4

-V<sub>GS</sub>, GATE-SOURCE VOLTAGE (V)

Figure 4 Typical Transfer Characteristics

5

6

V<sub>GS</sub> = -4.5V

V<sub>GS</sub> = -2.5V

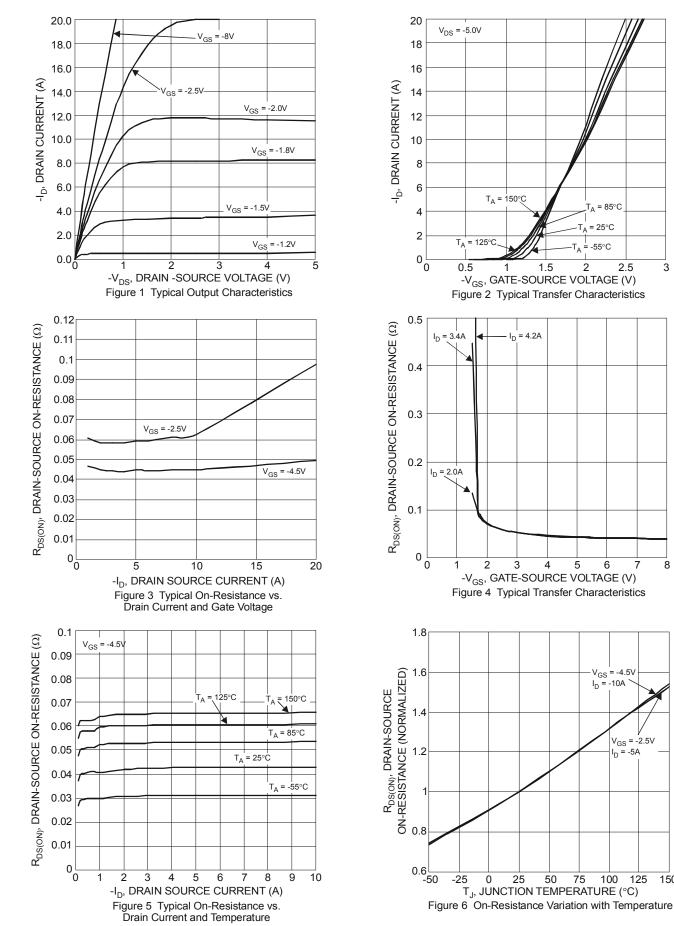
I<sub>D</sub> = -5A

I<sub>D</sub> = -10A

7

8

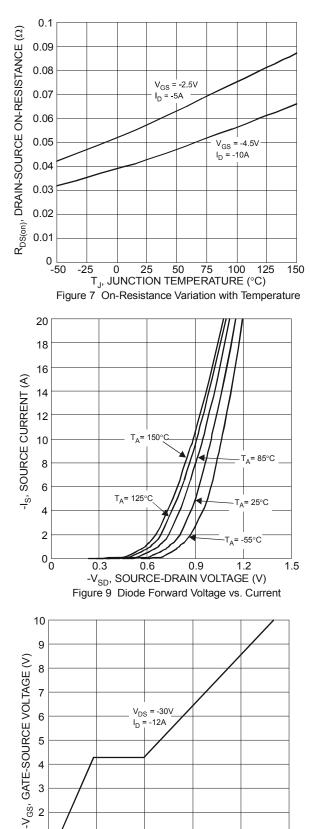
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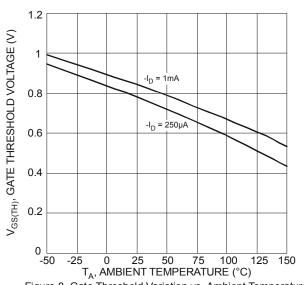


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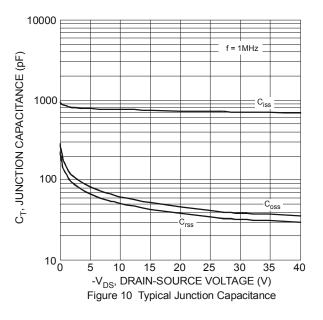
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3

6

9

Q<sub>q</sub>, TOTAL GATE CHARGE (nC) Figure 11 Gate-Charge Characteristics

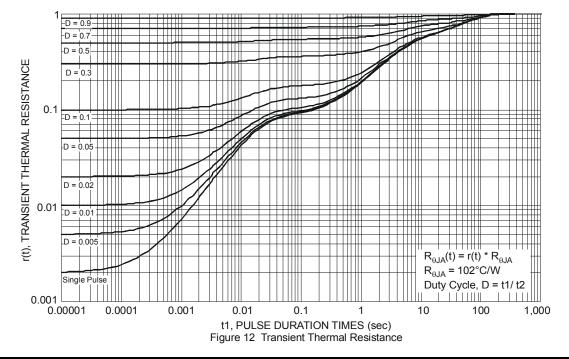
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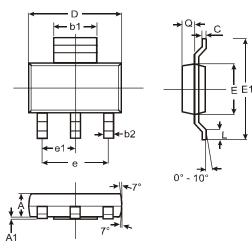
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# Package Outline Dimensions

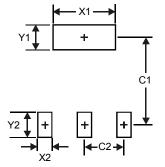
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



SOT223					
Dim	Min	Max	Тур		
Α	1.55	1.65	1.60		
A1	0.010	0.15	0.05		
b1	2.90	3.10	3.00		
b2	0.60	0.80	0.70		
С	0.20	0.30	0.25		
D	6.45	6.55	6.50		
E	3.45	3.55	3.50		
E1	6.90	7.10	7.00		
е			4.60		
e1		_	2.30		
L	0.85	1.05	0.95		
Q	0.84	0.94	0.89		
All Dimensions in mm					

## Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
X1	3.3
X2	1.2
Y1	1.6
Y2	1.6
C1	6.4
C2	2.3

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